



30V Complementary Enhancement Mode MOSFET

Voltage

30 / -30V

Current

4.4 /-3.1A

Features

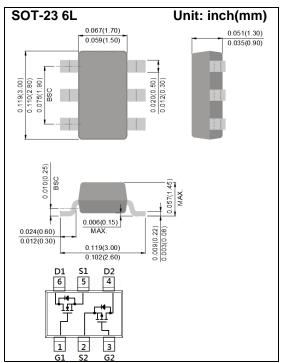
- Advanced Trench Process Technology
- Specially Designed for Switch Load, PWM Application, etc.
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: SOT-23 6L Package

• Terminals: Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.0005 ounces, 0.014 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

| PARAMET | SYMBOL | N-Ch LIMIT | P-Ch LIMIT | UNITS | |
|--|----------------------------------|------------------|-------------|-------------|-------|
| Drain-Source Voltage | | V _{DS} | 30 | -30 | V |
| Gate-Source Voltage | | V _{GS} | <u>+</u> 12 | <u>+</u> 12 | V |
| Continuous Drain Current | | I _D | 4.4 | -3.1 | Α |
| Pulsed Drain Current ^(Note 4) | | I _{DM} | 17.6 | -12.4 | Α |
| Power Dissipation | Ta=25°C | <u> </u> | 1. | 1.25 | |
| | Derate above 25°C | P _D | 10 | | mW/°C |
| Operating Junction and Storage | T _J ,T _{STG} | -55~150 | | °C | |
| Typical Thermal Resistance - Junction to Ambient ^(Note 3) | | R _{θJA} | 100 | | 100 |





N-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNITS |
|---|---------------------|---|------|------|--------------|-------|
| Static | | | • | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V, I _D =250uA | 30 | - | - | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | V _{DS} =V _{GS} , I _D =250uA | 0.4 | 0.72 | 1.2 | V |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} =10V, I _D =4.4A | - | 37 | 48 | |
| | | V _{GS} =4.5V, I _D =3.6A | - | 40 | 53 | mΩ |
| | | V _{GS} =2.5V, I _D =2.5A | - | 48 | 66 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =30V, V _{GS} =0V | - | - | 1 | uA |
| Gate-Source Leakage Current | Igss | V _{GS} = <u>+</u> 12V, V _{DS} =0V | - | - | <u>+</u> 100 | nA |
| Dynamic ^(Note 5) | | | | | | |
| Total Gate Charge | Q_g | \/ 45\/ 1 440 | - | 11.3 | - | nC |
| Gate-Source Charge | Qgs | V _{DS} =15V, I _D =4.4A, V _{GS} =10V ^(Note 1,2) | - | 1 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 1.2 | - | |
| Input Capacitance | Ciss | V _{DS} =15V, V _{GS} =0V, f=1.0MHZ | - | 447 | - | pF |
| Output Capacitance | Coss | | - | 34 | - | |
| Reverse Transfer Capacitance | Crss | | - | 22 | - | |
| Turn-On Delay Time | td _(on) | \/ 45\/ L 44A | - | 1.7 | - | |
| Turn-On Rise Time | tr | $\begin{array}{c} V_{DD}{=}15V,\ I_{D}{=}4.4A,\\ V_{GS}{=}10V,\\ R_{G}{=}3\Omega^{(Note\ 1,2)} \end{array}$ | - | 38 | - | ns |
| Turn-Off Delay Time | td _(off) | | - | 82 | - | |
| Turn-Off Fall Time | tf | | - | 64 | - | |
| Drain-Source Diode | | | | | | |
| Maximum Continuous Drain-Source Diode Forward Current | Is | | - | - | 1.5 | А |
| Diode Forward Voltage | V _{SD} | I _S =1.0A, V _{GS} =0V | - | 0.77 | 1.2 | V |

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Reja is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing





P-Channel Electrical Characteristics (T_A=25°C unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNITS |
|---|---------------------|---|------|-------|--------------|-------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V, I _D =-250uA | -30 | - | - | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | V _{DS} =V _{GS} , I _D =-250uA | -0.5 | -0.96 | -1.3 | V |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} =-10V, I _D =-3.1A | - | 82 | 98 | mΩ |
| | | V _{GS} =-4.5V, I _D =-2.2A | - | 91 | 114 | |
| | | V _{GS} =-2.5V, I _D =-1.1A | - | 115 | 165 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =-30V, V _{GS} =0V | - | - | -1 | uA |
| Gate-Source Leakage Current | I _{GSS} | V _{GS} = <u>+</u> 12V, V _{DS} =0V | - | - | <u>+</u> 100 | nA |
| Dynamic ^(Note 5) | | | | | | |
| Total Gate Charge | Q_g | V _{DS} =-15V, I _D =-3.1A, | - | 11 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 0.85 | - | |
| Gate-Drain Charge | Q_gd | V _{GS} =-10V ^(Note 1,2) | - | 1.4 | - | |
| Input Capacitance | Ciss | V _{DS} =-15V, V _{GS} =0V, f=1.0MHZ | - | 443 | - | pF |
| Output Capacitance | Coss | | - | 38 | - | |
| Reverse Transfer Capacitance | Crss | | - | 25 | - | |
| Turn-On Delay Time | td _(on) | \/ 45\/ L 0.44 | - | 2.5 | - | ns |
| Turn-On Rise Time | tr | V_{DD} =-15V, I_{D} =-3.1A, V_{GS} =-10V, R_{G} =6Ω(Note 1,2) | - | 32 | - | |
| Turn-Off Delay Time | td _(off) | | - | 161 | - | |
| Turn-Off Fall Time | tf | KG=012(Note 1,2) | - | 73 | - | |
| Drain-Source Diode | | | | | | |
| Maximum Continuous Drain-Source Diode Forward Current | Is | | - | - | -1.5 | А |
| Diode Forward Voltage | V _{SD} | I _S =-1.0A, V _{GS} =0V | - | -0.79 | -1.2 | V |

NOTES:

- 1. Pulse width<300us, Duty cycle<2%
- 2. Essentially independent of operating temperature typical characteristics.
- 3. ROJA is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.





N-Channel TYPICAL CHARACTERISTIC CURVES

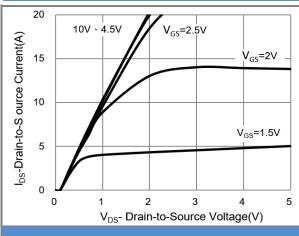


Fig.1 On-Region Characteristics

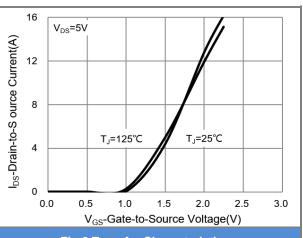


Fig.2 Transfer Characteristics

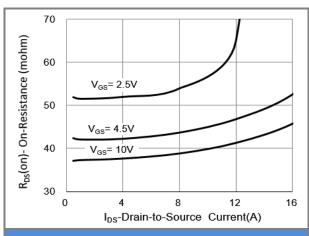


Fig.3 On-Resistance vs. Drain Current

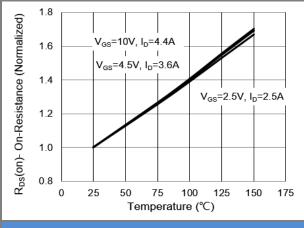
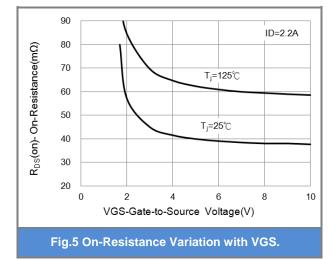
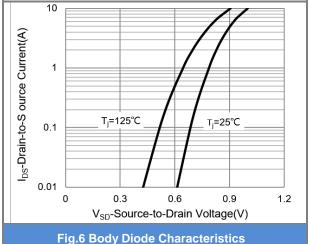


Fig.4 On-Resistance vs. Junction temperature









N-Channel TYPICAL CHARACTERISTIC CURVES

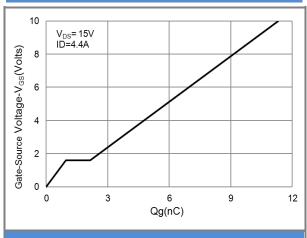


Fig.7 Gate-Charge Characteristics

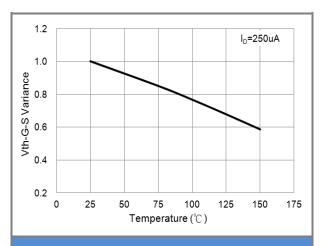


Fig.8 Threshold Voltage Variation with Temperature.

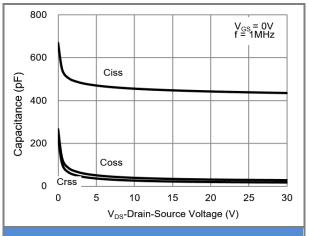


Fig.9 Capacitance vs. Drain-Source Voltage.





P-Channel TYPICAL CHARACTERISTIC CURVES

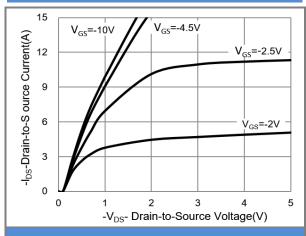


Fig.1 On-Region Characteristics

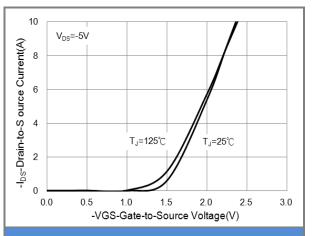


Fig.2 Transfer Characteristics

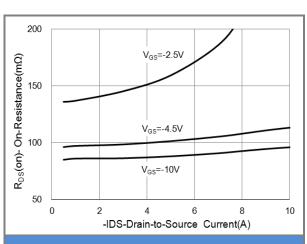


Fig.3 On-Resistance vs. Drain Current

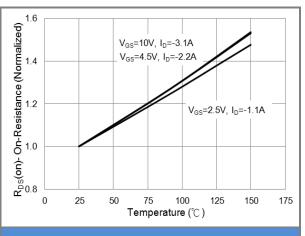
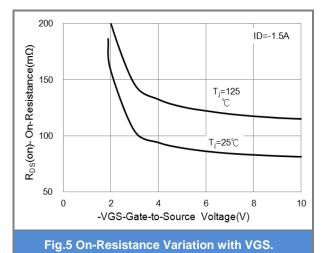
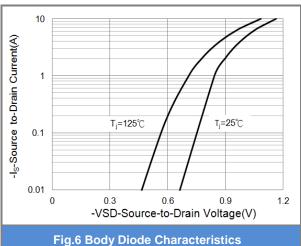


Fig.4 On-Resistance vs. Junction temperature









P-Channel TYPICAL CHARACTERISTIC CURVES

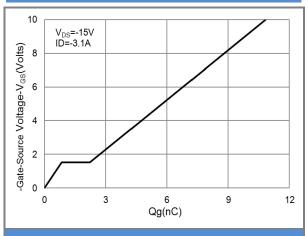


Fig.7 Gate-Charge Characteristics

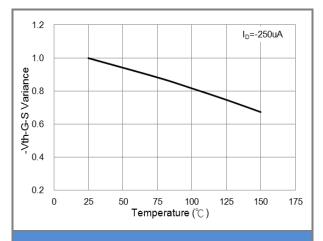


Fig.8 Threshold Voltage Variation with Temperature.

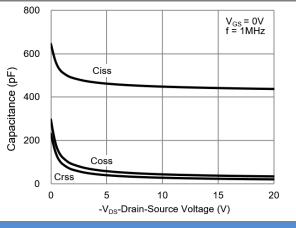


Fig.9 Threshold Voltage Variation with Temperature.

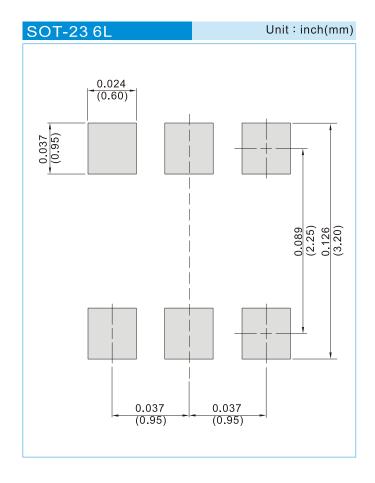




PART NO. PACKING CODE VERSION

| Part No. Packing Code | Package Type | Packing Type | Marking | Version |
|-----------------------|--------------|--------------------|---------|--------------------------------|
| PJS6604_S1_00001 | SOT-23 6L | 3K pcs / 7" reel | SC4 | Halogen free RoHS compliant |
| PJS6604_S2_00001 | SOT-23 6L | 10K pcs / 13" reel | SC4 | Halogen free RoHS compliant |

MOUNTING PAD LAYOUT







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